

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



In re Application of: Agarwal et al.

Art Unit: 2811

Application No. 09/590,795

Filed: June 8, 2000

For: METHODS FOR FORMING AND INTEGRATED  
CIRCUIT STRUCTURES CONTAINING  
RUTHENIUM AND TUNGSTEN CONTAINING  
LAYERS

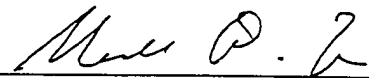
Examiner: Cuong Q. Nguyen

Date: October 29, 2001

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CERTIFICATE OF MAILING

I hereby certify that this paper and the documents referred  
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Attorney for Applicant

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**RESPONSE TO RESTRICTION/ELECTION REQUIREMENT**

In response to the Office action of September 28, 2001, please amend the subject application as follows:

**In the claims:**

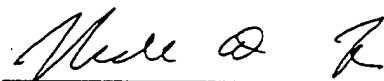
Please cancel claims 43-58, 64-65, and 71 without prejudice.

**REMARKS**

By this Amendment, Applicants elect the claims of Species I (claims 1-42, 59-63, and 66-70) for prosecution in the subject application and request cancellation of claims 43-58, 64-65, and 71 without prejudice. Applicants reserve the right to prosecute the non-elected claims in corresponding divisional applications.

Respectfully submitted,

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